

NCP6361 WLCSP9 Evaluation Board User's Manual



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EVAL BOARD USER'S MANUAL

Introduction

This document gives a detailed description of the NCP6361 Evaluation Board (WLCSP9) with the Bill Of Material (BOM), board schematic and layout. The appropriate laboratory test setups are also provided. The NCP6361 Evaluation Board has been designed to help for a quick evaluation of the NCP6361 buck converter.

This document has to be used together with the NCP6361 datasheet. The datasheet contains full technical details regarding the NCP6361 specifications and operation. The board (FR4 material) is implemented in 4 metal layers. The top and bottom layers have thicknesses of 35 μm (1 oz). The PCB thickness is 1.6 mm with dimensions of 77 mm by 55 mm (see Figure 1).



Figure 1. Evaluation Board Picture

EQUIPMENT

Table 1. RECOMMENDED EXAMPLE OF EQUIPMENT

Description	Main Features	Example of Equipment (Note 1)	Qty.
Regulated Power Supply	1.5 A DC Current capability	Tektronix PS2520G GW INSTEK PPT3615	1
Multimeter		Keitley 2000 or 2001	2
Sourcemeter	3 A DC Current capability	Keitley 2420	2
Oscilloscope	500 MHz Bandwidth, four channel scope, min 1 Mbit memory per channel (Note 2)	Tecktronix TDS744, 754 or 784 / TDS5054 series or Lecroy WR5060 TDS5104B, 1 GHz, 5 GS/s	1
Voltage probe	3 probes 500 MHz Bandwidth	Tektronix P6139A / P5050	3
Current probe	1 probe	Tektronix TCP 202	
Waveform generator	Arbitrary/Fonction generator	Tektronix AFG 3102 Dual channel, 100 MHz	1
SMB Cable		VCON	1

1. Equipment used in the context of this Evaluation Board User's Manual
2. Greater Scope memory per channel offers better resolution

QUICK TEST PROCEDURE

(see Figure 2)

Initial Setup:

The initial setup given here is recommended before starting measurements on the evaluation board.

- Jumper Configuration: initial / default setup
 - ◆ LTR1 not connected
 - ◆ LTR2 connected – Can be used for visualizing the current in the inductor (ILX) using an oscilloscope current probe
 - ◆ LTR3 connected – Connect FB pin to Vout

- ◆ S1: Enable pin; default with jumper connected to VBAT (Logic Level High), device is activated by default
- ◆ S2: ByPass Enable option, default with jumper connected to GND (Logic Level Low), By Pass not activated
- ◆ S3: Frequency Selection pin, default with jumper connected to GND (Logic level Low), FSEL = 0 \Leftrightarrow Frequency = 6 MHz selected

Table 2. SWITCHING FREQUENCY SELECTION

FSEL	Buck Converter Switching Frequency (F _{sw})	Inductor (L _X)
0	6 MHz (24 MHz / 4)	0.47 μ H
1	3.429 MHz (24 MHz / 7)	1 μ H

- Connect Vin (VBAT) with VBAT tuned at 3.7 V for example
- Connect VCON with VCON tuned at 0.8 V for example \Rightarrow Vout = 0.8V x 2.5 = 2V
- Connect load (8 Ω or 10 Ω respectively 250 mA or 200 mA considering Vout = 2 V) or connect a current source tuned with 100 mA (as initial load value)
- Connect voltage probe or multi-meter on Vout test point
- Other test points can be eventually checked: VCON (TP9), FB, VBAT, EN, FSEL and BPEN
- SW test point is available as well
- Apply VBAT = 3.7 V first then VCON = 0.8 V and finally IOUT (100 mA) if current source connected
- Check Vout = 2 V
- VBAT can vary from 2.5 V to 5.5 V according to datasheet

- VCON can vary from 0.16 V to 1.4 V with a corresponding respective Vout of 0.4 V typical and 3.5 V typical
- Output current can vary from 0 to 800 mA in PWM mode and up to 1.2 A in By Pass mode

Operating Modes:

- 4 operating modes are available: they can be checked by sweeping VCON according to datasheet specification and below rough guide lines:
 - ◆ Sleep Mode with VCON below about 0.125 V
 - ◆ PFM Mode with VCON above 0.125 V
 - ◆ PWM Mode when Iout above about 200 mA
 - ◆ By Pass Mode when Vout close to Vin such as Vin – Vout below about 200 mV or by forcing bypass mode with pin BPEN

BOARD DESCRIPTION

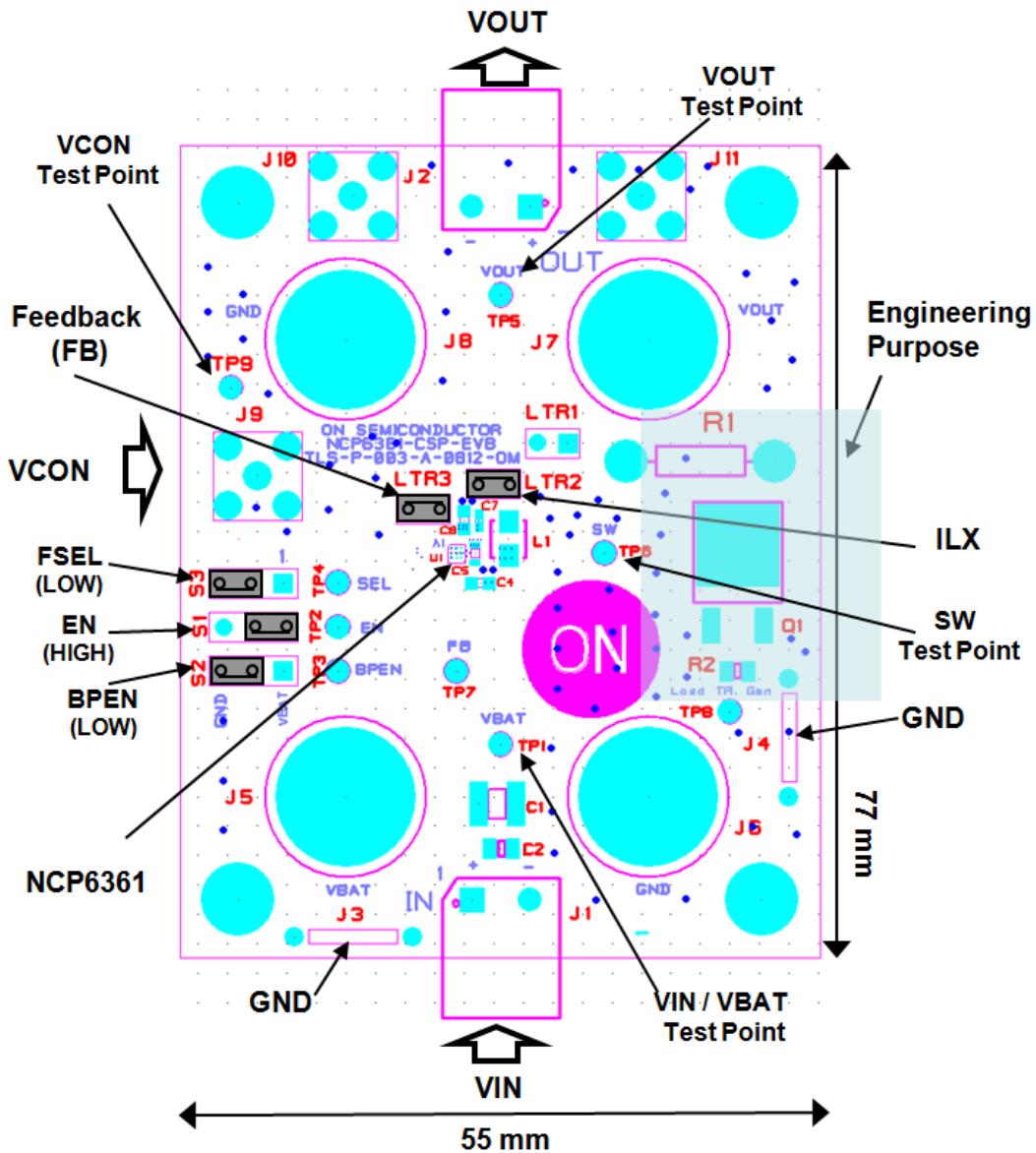


Figure 2. Board Description

BOARD SCHEMATIC

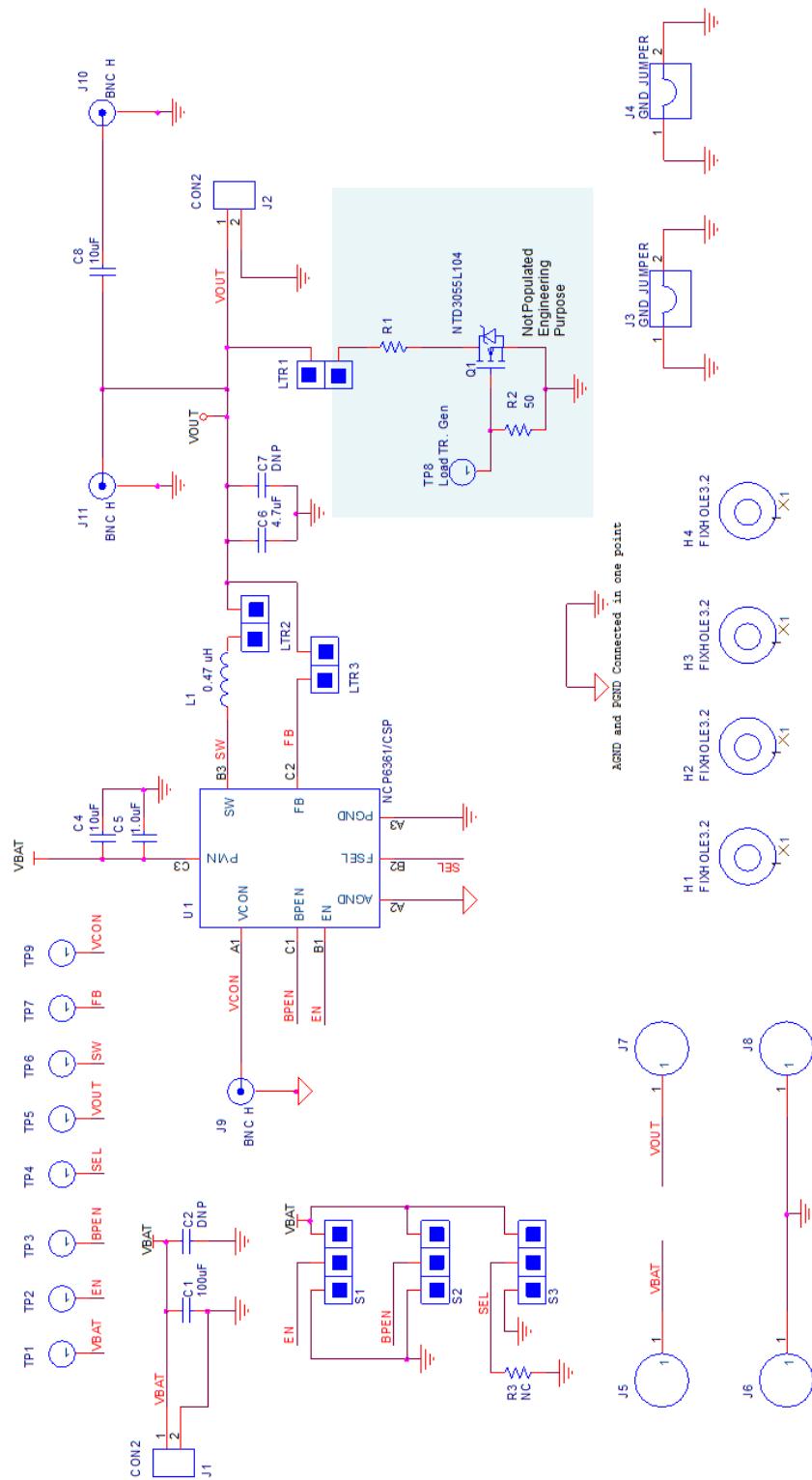


Figure 3. Board Schematic

NCP6361EVB

Table 3. BILL OF MATERIAL – NCP6361 EVALUATION BOARD

Designator	Qty	Description	Value	Tol	Footprint	Manufacturer	Manufacturer Part Number	Lead Free
C1	1	CAP CER 100uF 6.3V 20% X5R 1210	100 μ F	20%	1210			Yes
C2	1	0805	DNP	–	0805		DNP	Yes
C4, C8	2	CAP CER 10uF 16V 10% X5R 0603	10 μ F	10%	0603			Yes
C5	1	CAP CER 1uF 16V X7R 10% 0603	1 μ F	10%	0603			Yes
C6	1	CAP CER 4.7uF 16V X7R 0603	4.7 μ F	5%	0603			Yes
C7	1	0402	DNP	–	0402		DNP	
R1	1	STRAP	DNP	–			Engineering, DNP	Yes
R2	1	0603 SMD	50, DNP	–	0603			Yes
R3	1	DNP	Open	–	0805		DNP	–
L1	1	2016, inductor 0.47 μ H (1 μ H)	0.47 μ H (1 μ H)		2016	TDK TOKO	TFM201610A-R47M-T00 DFE201612R-H-R47N	Yes
TP1, TP5	2	VBAT, VOUT, Clip Test Point, Hole Diameter 1.6 mm (0.063 mil)	–	–	TP_1.6MMHOLE_KEYSTONE_5010	Keystone	5010	Yes
TP2, TP3, TP4	3	EN, BPEN, FSEL, Clip Test Point, Hole Diameter 1.6 mm (0.063 mil)	–	–	TP_1.6MMHOLE_KEYSTONE_5010	Keystone	5010	Yes
TP6	1	SW, Contact Test Point	–	–	NA	NA	NA	Yes
TP7	1	FB, Clip Test Point, Hole Diameter 1.6 mm (0.063 mil)	–	–	TP_1.6MMHOLE_KEYSTONE_5010	Keystone	5010	Yes
TP8	1	Load Transient Gen, Clip Test Point, Hole Diameter 1.6 mm (0.063 mil)	–	–	TP_1.6MMHOLE_KEYSTONE_5010	Keystone	5010	Yes
TP9	1	VCON, Clip Test Point, Hole Diameter 1.6mm (0.063 mil)	–	–	TP_1.6MMHOLE_KEYSTONE_5010	Keystone	5010	Yes
J1, J2	2	VBAT, VOUT, 2-Pins Male Connector, 5.08 mm Step	–	–	CON2	Phoenix Contact	MSTBA2.52G5.08	Yes
J3, J4	2	Ground Strap, Brass, Diameter 1.0 mm, Pitch 10.16 mm, Height 9.9 mm	–	–	GND_STRP	HARWIN	D3082-46	Yes
J5, J6, J7, J8	4	VBAT, VOUT banana connectors, DC 60 V 16 A. (Ø 4 mm nickel-plated brass socket)	–		BANANA JACK	Hirschmann	BO 10	Yes
J9, J10, J11	3	SMB connectors	Populate J9 only		SMB/V	IMS	111510001	Yes
LTR1, LTR2, LTR3	3	Breakable Single Row Header (2 Pins)	–	–	CON2-2.54	TYCO Amp	5-826629-0	Yes
S1, S2, S3	3	EN, BPEN, FSEL, Breakable Single Row Header (3 Pins)	–	–	CON3-2.54	TYCO Amp	5-826629-0	Yes
U1	1	NCP6361	–	–	WLCSPI9	ON Semiconductor	NCP6361	Yes
Q1	1	NTD3055L104	DNP		DPACK-1234	ON Semiconductor	Engineering, DNP	Yes
H1, H2, H3, H4	4	Standoff nut & Standoff screw	–	–	STANDOFF_HOLE	Keystone Electronics	1903C & 4814K-ND	Yes

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